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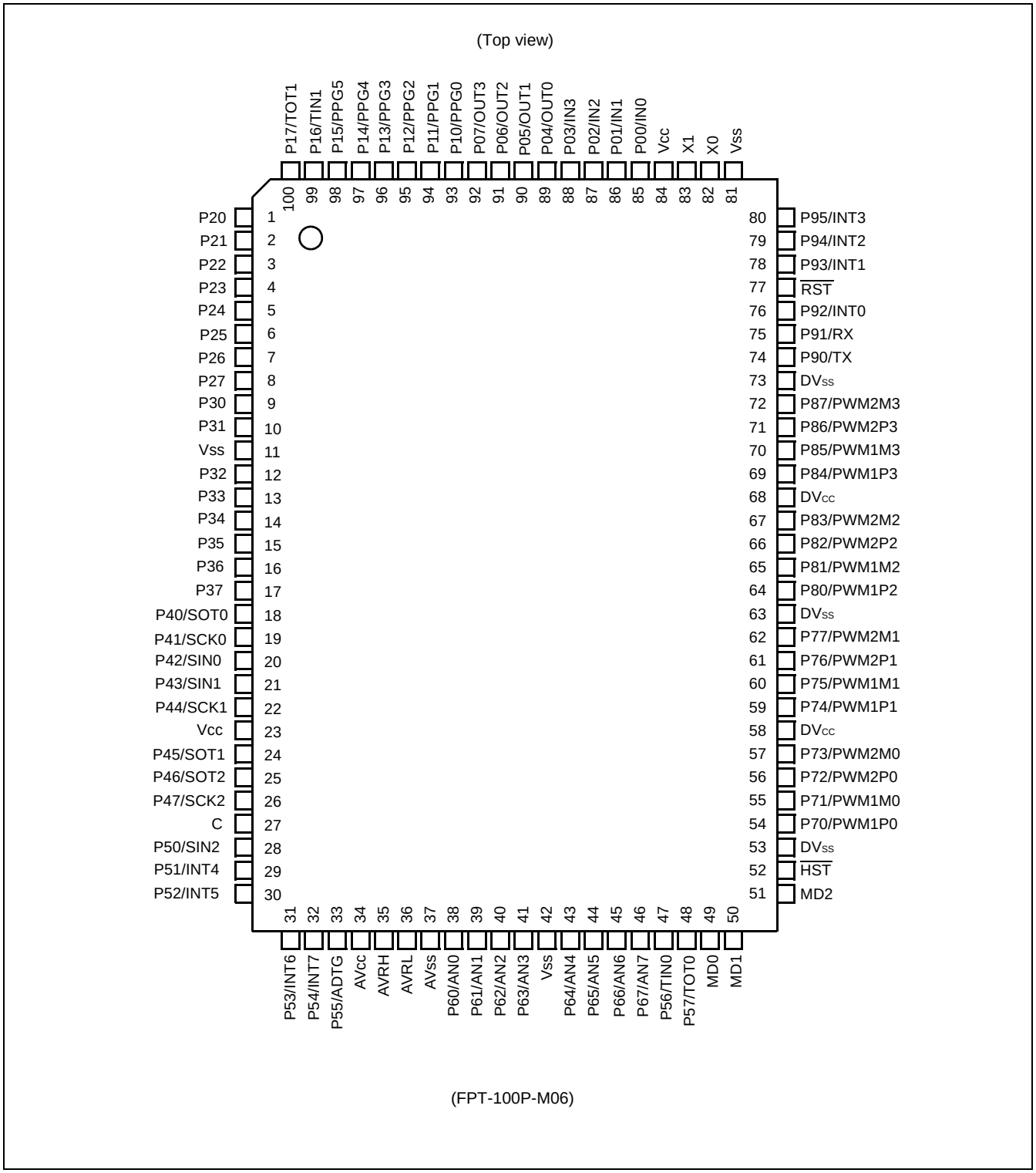
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

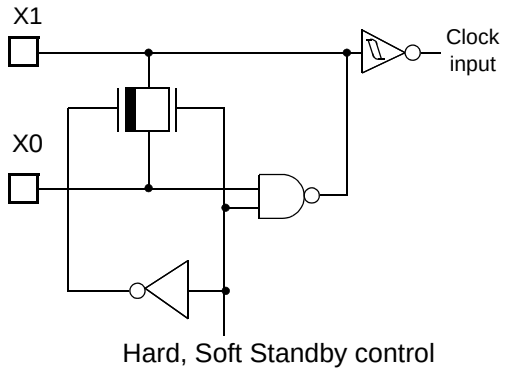
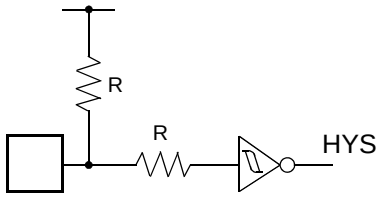
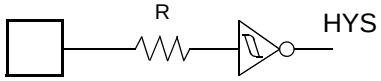
Details	
Product Status	Active
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	78
Program Memory Size	128KB (128K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90598gpf-g-140-bnd

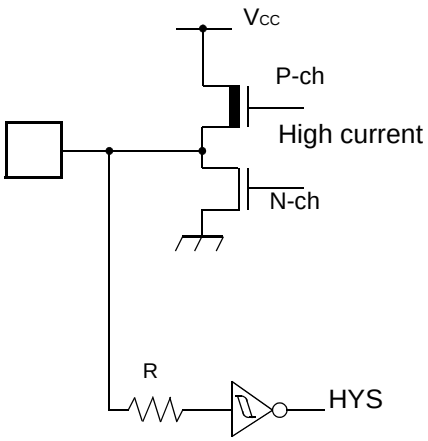
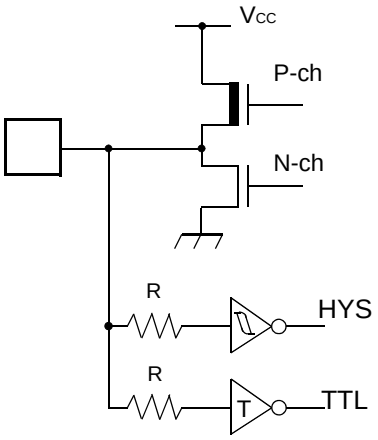
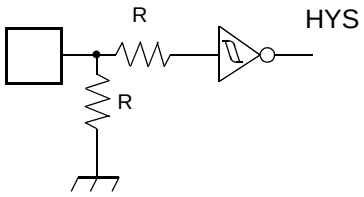
2. Pin Assignment



Pin no.	Pin name	Circuit type	Function
76	P92	D	General purpose IO
	INT0		External interrupt input for INT0
78 to 80	P93 to P95	D	General purpose IO
	INT1 to INT3		External interrupt input for INT1 to INT3
58, 68	DV_{CC}	—	Dedicated power supply pins for the high current output buffers (Pin No. 54 to 72)
53, 63, 73	DV_{SS}	—	Dedicated ground pins for the high current output buffers (Pin No. 54 to 72)
34	AV_{CC}	Power supply	Dedicated power supply pin for the A/D Converter
37	AV_{SS}	Power supply	Dedicated ground pin for the A/D Converter
35	AVRH	Power supply	Upper reference voltage input for the A/D Converter
36	AVRL	Power supply	Lower reference voltage input for the A/D Converter
49, 50	MD0 MD1	C	Operating mode selection input pins. These pins should be connected to V_{CC} or V_{SS}.
51	MD2	H	Operating mode selection input pin. This pin should be connected to V_{CC} or V_{SS}.
27	C	—	External capacitor pin. A capacitor of 0.1μF should be connected to this pin and V_{SS}.
23, 84	V_{CC}	Power supply	Power supply pins (5.0 V).
11, 42, 81	V_{SS}	Power supply	Ground pins (0.0 V).

4. I/O Circuit Type

Circuit Type	Circuit	Remarks
A		■ Oscillation feedback resistor: 1 MΩ approx.
B		■ Hysteresis input with pull-up Resistor: 50 kΩ approx.
C		■ Hysteresis input

Circuit Type	Circuit	Remarks
F		■ CMOS high current output ■ CMOS Hysteresis input
G		■ CMOS output ■ CMOS Hysteresis input ■ TTL input (MB90F598G, only in Flash mode)
H		■ Hysteresis input Pull-down Resistor: 50 kΩ approx. (except MB90F598G)

5. Handling Devices

(1) Make Sure that the Voltage not Exceed the Maximum Rating (to Avoid a Latch-up).

In CMOS ICs, a latch-up phenomenon is caused when an voltage exceeding V_{CC} or an voltage below V_{SS} is applied to input or output pins or a voltage exceeding the rating is applied across V_{CC} and V_{SS}.

When a latch-up is caused, the power supply current may be dramatically increased causing resultant thermal break-down of devices. To avoid the latch-up, make sure that the voltage not exceed the maximum rating.

In turning on/turning off the analog power supply, make sure the analog power voltage (AV_{CC}, AVRH, DV_{CC}) and analog input voltages not exceed the digital voltage (V_{CC}).

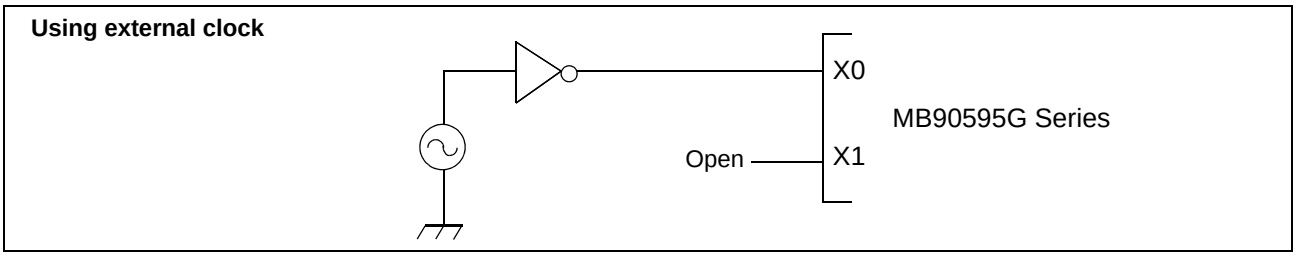
(2) Treatment of Unused Pins

Unused input pins left open may cause abnormal operation, or latch-up leading to permanent damage. Unused input pins should be pulled up or pulled down through at least 2 kΩ resistance.

Unused input/output pins may be left open in output state, but if such pins are in input state they should be handled in the same way as input pins.

(3) Using external clock

In using the external clock, drive X0 pin only and leave X1 pin unconnected.

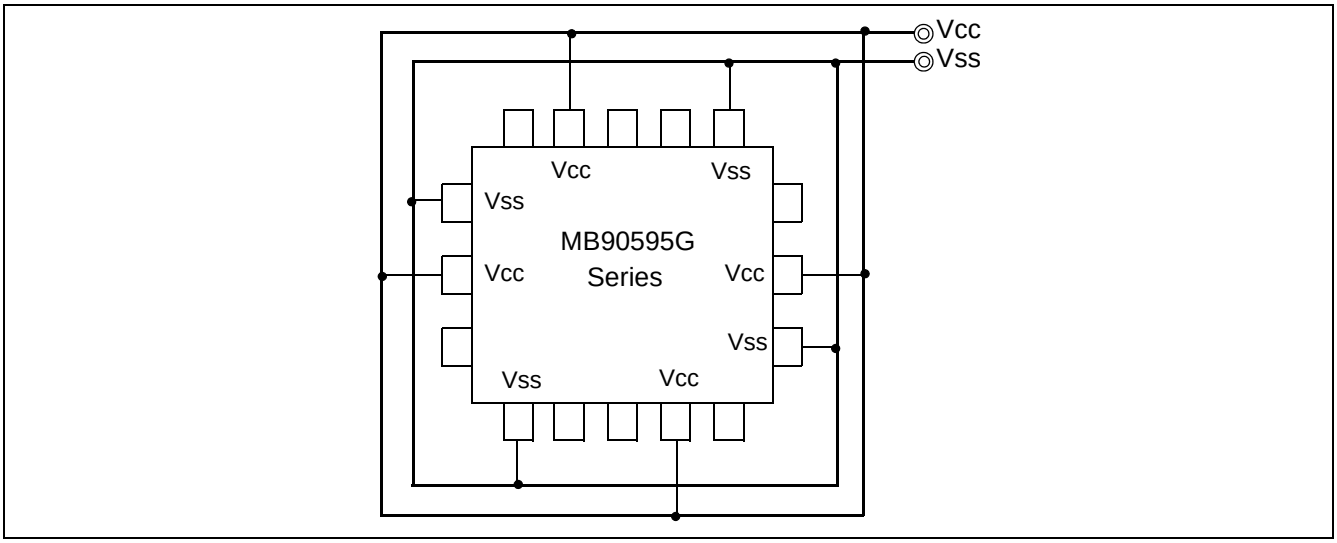


(4) Power supply pins (Vcc/Vss)

In products with multiple V_{cc} or V_{ss} pins, pins with the same potential are internally connected in the device to avoid abnormal operations including latch-up. However, you must connect the pins to an external power and a ground line to lower the electro-magnetic emission level, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total current rating (See the figure below.)

Make sure to connect V_{cc} and V_{ss} pins via lowest impedance to power lines.

It is recommended to provide a bypass capacitor of around 0.1 μF between V_{cc} and V_{ss} pins near the device.



(5) Pull-up/down resistors
The MB90595G Series does not support internal pull-up/down resistors. Use external components where needed.

(6) Crystal Oscillator Circuit
Noises around X0 or X1 pins may cause abnormal operations. Make sure to provide bypass capacitors via shortest distance from X0, X1 pins, crystal oscillator (or ceramic resonator) and ground lines, and make sure that lines of oscillation circuit not cross the lines of other circuits.
A printed circuit board artwork surrounding the X0 and X1 pins with ground area for stabilizing the operation is highly recommended.

(7) Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs
Make sure to turn on the A/D converter power supply (AV_{CC}, AVRH, AVRL) and analog inputs (AN0 to AN7) after turning-on the digital power supply (V_{CC}).
Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage does not exceed AVRH or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

(8) Connection of Unused Pins of A/D Converter
Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AVRH = DV_{CC} = V_{SS}$.

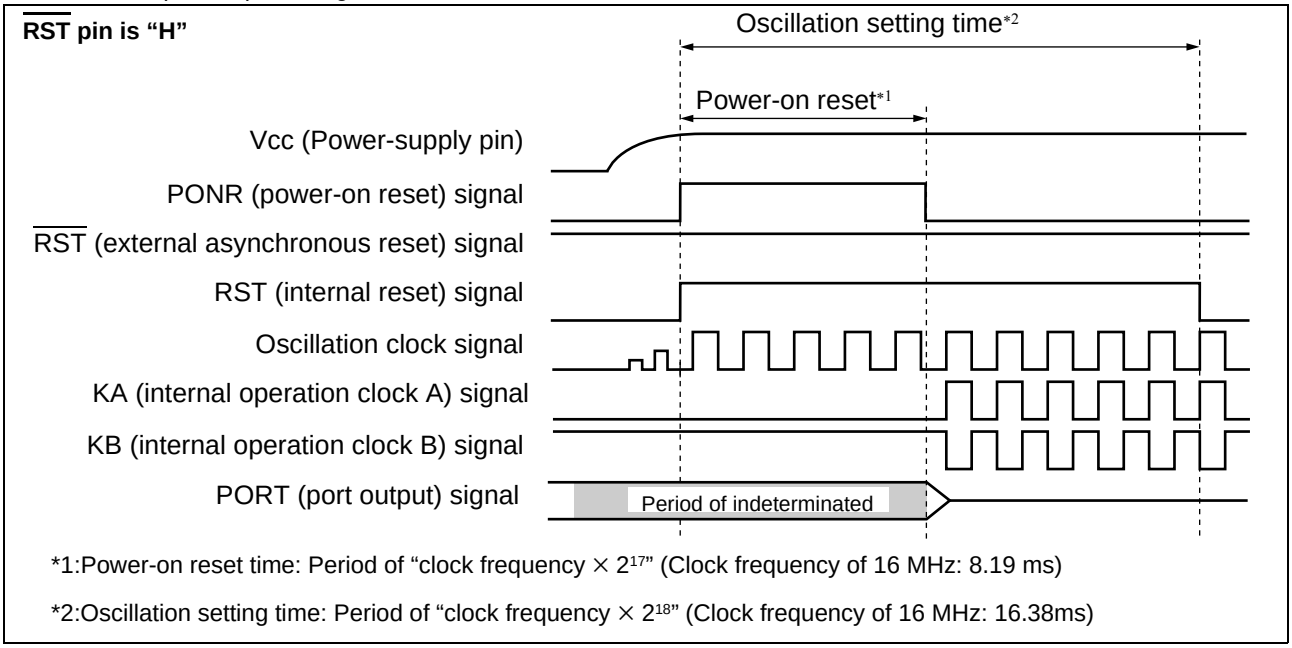
(9) N.C. Pin
The N.C. (internally connected) pin must be opened for use.

(10) Notes on Energization
To prevent the internal regulator circuit from malfunctioning, set the voltage rise time during energization at 50 µs or more (0.2 V to 2.7 V).

(11) Indeterminate outputs from ports 0 and 1 (MB90V595G only)
During oscillation setting time of step-down circuit (during a power-on reset) after the power is turned on, the outputs from ports 0 and 1 become following state.

■ If $\overline{RST}$ pin is “H”, the outputs become indeterminate.

■ If $\overline{RST}$ pin is “L”, the outputs become high-impedance.
Pay attention to the port output timing shown as follows.



*1:Power-on reset time: Period of “clock frequency × 2^{17}” (Clock frequency of 16 MHz: 8.19 ms)

*2:Oscillation setting time: Period of “clock frequency × 2^{18}” (Clock frequency of 16 MHz: 16.38ms)

Address	Register	Abbreviation	Access	Peripheral	Initial value
29H to 2AH	Reserved				
2BH	Serial IO Prescaler	SCDCR	R/W	Serial IO	0 _ _ _ 1 1 1 1B
2CH	Serial Mode Control Register (low-order)	SMCS	R/W		_ _ _ _ 0 0 0 0B
2DH	Serial Mode Control Register (high-order)	SMCS	R/W		0 0 0 0 0 0 1 0B
2EH	Serial Data Register	SDR	R/W		XXXXXXXXB
2FH	Edge Selector	SES	R/W		_ _ _ _ _ _ _ 0B
30H	External Interrupt Enable Register	ENIR	R/W	External Interrupt	0 0 0 0 0 0 0 0B
31H	External Interrupt Request Register	EIRR	R/W		XXXXXXXXB
32H	External Interrupt Level Register	ELVR	R/W		0 0 0 0 0 0 0 0B
33H	External Interrupt Level Register	ELVR	R/W		0 0 0 0 0 0 0 0B
34H	A/D Control Status Register 0	ADCS0	R/W	A/D Converter	0 0 0 0 0 0 0 0B
35H	A/D Control Status Register 1	ADCS1	R/W		0 0 0 0 0 0 0 0B
36H	A/D Data Register 0	ADCR0	R		XXXXXXXXB
37H	A/D Data Register 1	ADCR1	R/W		0 0 0 0 1 _ XXB
38H	PPG0 Operation Mode Control Register	PPGC0	R/W	16-bit Programmable Pulse Generator 0/1	0 _ 0 0 0 _ _ 1B
39H	PPG1 Operation Mode Control Register	PPGC1	R/W		0 _ 0 0 0 0 0 1B
3AH	PPG0, 1 Output Pin Control Register	PPG01	R/W		0 0 0 0 0 0 _ _B
3BH	Reserved				
3CH	PPG2 Operation Mode Control Register	PPGC2	R/W	16-bit Programmable Pulse Generator 2/3	0 _ 0 0 0 _ _ 1B
3DH	PPG3 Operation Mode Control Register	PPGC3	R/W		0 _ 0 0 0 0 0 1B
3EH	PPG2, 3 Output Pin Control Register	PPG23	R/W		0 0 0 0 0 0 _ _B
3FH	Reserved				
40H	PPG4 Operation Mode Control Register	PPGC4	R/W	16-bit Programmable Pulse Generator 4/5	0 _ 0 0 0 _ _ 1B
41H	PPG5 Operation Mode Control Register	PPGC5	R/W		0 _ 0 0 0 0 0 1B
42H	PPG4, 5 Output Pin Control Register	PPG45	R/W		0 0 0 0 0 0 _ _B
43H	Reserved				
44H	PPG6 Operation Mode Control Register	PPGC6	R/W	16-bit Programmable Pulse Generator 6/7	0 _ 0 0 0 _ _ 1B
45H	PPG7 Operation Mode Control Register	PPGC7	R/W		0 _ 0 0 0 0 0 1B
46H	PPG6, 7 Output Pin Control Register	PPG67	R/W		0 0 0 0 0 0 _ _B
47H	Reserved				
48H	PPG8 Operation Mode Control Register	PPGC8	R/W	16-bit Programmable Pulse Generator 8/9	0 _ 0 0 0 _ _ 1B
49H	PPG9 Operation Mode Control Register	PPGC9	R/W		0 _ 0 0 0 0 0 1B
4AH	PPG8, 9 Output Pin Control Register	PPG89	R/W		0 0 0 0 0 0 _ _B
4BH	Reserved				

(Continued)

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Address	Register	Abbreviation	Access	Peripheral	Initial value
192C$_H$	Output Compare Register 2 (low-order)	OCCP2	R/W	Output Compare 2/3	XXXXXXXX$_B$
192D$_H$	Output Compare Register 2 (high-order)	OCCP2	R/W		XXXXXXXX$_B$
192E$_H$	Output Compare Register 3 (low-order)	OCCP3	R/W		XXXXXXXX$_B$
192F$_H$	Output Compare Register 3 (high-order)	OCCP3	R/W		XXXXXXXX$_B$
1930$_H$ to 19FF$_H$	Reserved				
1A00$_H$ to 1AFF$_H$	CAN Controller. Refer to section about CAN Controller				
1B00$_H$ to 1BFF$_H$	CAN Controller. Refer to section about CAN Controller				
1C00$_H$ to 1EFF$_H$	Reserved				
1FF0$_H$	Program Address Detection Register 0 (low-order)	PADR0	R/W	Address Match Detection Function	XXXXXXXX$_B$
1FF1$_H$	Program Address Detection Register 0 (middle-order)				XXXXXXXX$_B$
1FF2$_H$	Program Address Detection Register 0 (high-order)				XXXXXXXX$_B$
1FF3$_H$	Program Address Detection Register 1 (low-order)	PADR1	R/W		XXXXXXXX$_B$
1FF4$_H$	Program Address Detection Register 1 (middle-order)				XXXXXXXX$_B$
1FF5$_H$	Program Address Detection Register 1 (high-order)				XXXXXXXX$_B$
1FF6$_H$ to 1FFF$_H$	Reserved				

■ Description for Read/Write
R/W : Readable/writable
R : Read only
W : Write only

■ Description of initial value
0 : the initial value of this bit is "0".
1 : the initial value of this bit is "1".
X : the initial value of this bit is undefined.
_ : this bit is unused. the initial value is undefined.

Note: : Addresses in the range of 0000$_H$ to 00FF$_H$, which are not listed in the table, are reserved for the primary functions of the MCU. A read access to these reserved addresses results in reading “X”, and any write access should not be performed.

(Continued)

Address	Register	Abbreviation	Access	Initial Value
001B08H	IDE register	IDER	R/W	XXXXXXXX XXXXXXXXB
001B09H				
001B0AH	Transmit RTR register	TRTRR	R/W	00000000 00000000B
001B0BH				
001B0CH	Remote frame receive waiting register	RFWTR	R/W	XXXXXXXX XXXXXXXXB
001B0DH				
001B0EH	Transmit interrupt enable register	TIER	R/W	00000000 00000000B
001B0FH				
001B10H	Acceptance mask select register	AMSR	R/W	XXXXXXXX XXXXXXXXB
001B11H				
001B12H				XXXXXXXX XXXXXXXXB
001B13H				
001B14H	Acceptance mask register 0	AMR0	R/W	XXXXXXXX XXXXXXXXB
001B15H				
001B16H				XXXXX--- XXXXXXXXB
001B17H				
001B18H	Acceptance mask register 1	AMR1	R/W	XXXXXXXX XXXXXXXXB
001B19H				
001B1AH				XXXXX--- XXXXXXXXB
001B1BH				

9.2 List of Message Buffers (ID Registers)

Address	Register	Abbreviation	Access	Initial Value
001A00H to 001A1FH	General-purpose RAM	--	R/W	XXXXXXXXB to XXXXXXXXB
001A20H	ID register 0	IDR0	R/W	XXXXXXXX XXXXXXXXB
001A21H				
001A22H				XXXXX--- XXXXXXXXB
001A23H				
001A24H	ID register 1	IDR1	R/W	XXXXXXXX XXXXXXXXB
001A25H				
001A26H				XXXXX--- XXXXXXXXB
001A27H				
001A28H	ID register 2	IDR2	R/W	XXXXXXXX XXXXXXXXB
001A29H				
001A2AH				XXXXX--- XXXXXXXXB
001A2BH				

Address	Register	Abbreviation	Access	Initial Value
001A2C$_H$	ID register 3	IDR3	R/W	XXXXXXXX XXXXXXXX$_B$
001A2D$_H$				
001A2E$_H$				XXXXX--- XXXXXXXX$_B$
001A2F$_H$				
001A30$_H$	ID register 4	IDR4	R/W	XXXXXXXX XXXXXXXX$_B$
001A31$_H$				
001A32$_H$				XXXXX--- XXXXXXXX$_B$
001A33$_H$				
001A34$_H$	ID register 5	IDR5	R/W	XXXXXXXX XXXXXXXX$_B$
001A35$_H$				
001A36$_H$				XXXXX--- XXXXXXXX$_B$
001A37$_H$				
001A38$_H$	ID register 6	IDR6	R/W	XXXXXXXX XXXXXXXX$_B$
001A39$_H$				
001A3A$_H$				XXXXX--- XXXXXXXX$_B$
001A3B$_H$				
001A3C$_H$	ID register 7	IDR7	R/W	XXXXXXXX XXXXXXXX$_B$
001A3D$_H$				
001A3E$_H$				XXXXX--- XXXXXXXX$_B$
001A3F$_H$				

(Continued)

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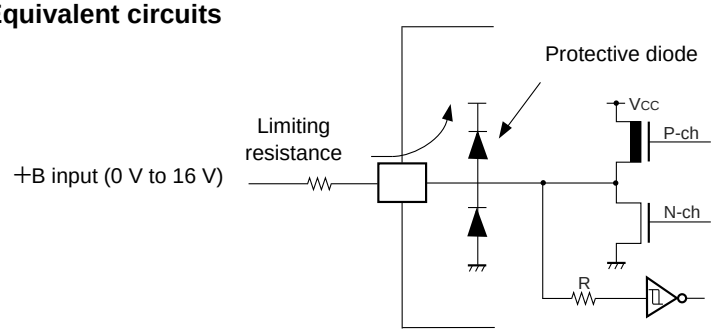
Address	Register	Abbreviation	Access	Initial Value
001A40H	ID register 8	IDR8	R/W	XXXXXXXX XXXXXXXXB
001A41H				
001A42H				XXXXX--- XXXXXXXXB
001A43H				
001A44H	ID register 9	IDR9	R/W	XXXXXXXX XXXXXXXXB
001A45H				
001A46H				XXXXX--- XXXXXXXXB
001A47H				
001A48H	ID register 10	IDR10	R/W	XXXXXXXX XXXXXXXXB
001A49H				
001A4AH				XXXXX--- XXXXXXXXB
001A4BH				
001A4CH	ID register 11	IDR11	R/W	XXXXXXXX XXXXXXXXB
001A4DH				
001A4EH				XXXXX--- XXXXXXXXB
001A4FH				
001A50H	ID register 12	IDR12	R/W	XXXXXXXX XXXXXXXXB
001A51H				
001A52H				XXXXX--- XXXXXXXXB
001A53H				
001A54H	ID register 13	IDR13	R/W	XXXXXXXX XXXXXXXXB
001A55H				
001A56H				XXXXX--- XXXXXXXXB
001A57H				
001A58H	ID register 14	IDR14	R/W	XXXXXXXX XXXXXXXXB
001A59H				
001A5AH				XXXXX--- XXXXXXXXB
001A5BH				
001A5CH	ID register 15	IDR15	R/W	XXXXXXXX XXXXXXXXB
001A5DH				
001A5EH				XXXXX--- XXXXXXXXB
001A5FH				

Notes:

- For a peripheral module with two interrupt for a single interrupt number, both interrupt request flags are cleared by the EI²OS interrupt clear signal.
- At the end of EI²OS, the EI²OS clear signal will be asserted for all the interrupt flags assigned to the same interrupt number. If one interrupt flag starts the EI²OS and in the meantime another interrupt flag is set by hardware event, the later event is lost because the flag is cleared by the EI²OS clear signal caused by the first event. So it is recommended not to use the EI²OS for this interrupt number.
- If EI²OS is enabled, EI²OS is initiated when one of the two interrupt signals in the same interrupt control register (ICR) is asserted. This means that different interrupt sources share the same EI²OS Descriptor which should be unique for each interrupt source. For this reason, when one interrupt source uses the EI²OS, the other interrupt should be disabled.

- The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
- Note that if a +B signal is input when the microcontroller current is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on result.
- Care must be taken not to leave the +B input pin open.
- Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal input.
- Sample recommended circuits :

• Input/Output Equivalent circuits



Note: : Average output current = operating current × operating efficiency

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

11.2 Recommended Conditions

(V_{SS} = AV_{SS} = 0.0 V)

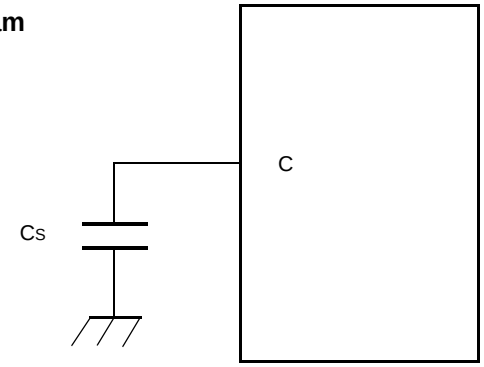
Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC} AV_{CC}	4.5	5.0	5.5	V	Under normal operation
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smooth capacitor	C_S	0.022	0.1	1.0	µF	*
Operating temperature	T_A	–40	—	+85	°C	

*: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The smoothing capacitor to be connected to the V_{CC} pin must have a capacitance value higher than C_S.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

- **C Pin Connection Diagram**



11.3 DC Characteristics

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input H voltage	V_{IHS}	CMOS hysteresis input pin	—	0.8 V_{CC}	—	V_{CC} +0.3	V	
	V_{IHM}	MD input pin	—	V_{CC} – 0.3	—	V_{CC} +0.3	V	
Input L voltage	V_{ILS}	CMOS hysteresis input pin	—	V_{SS} – 0.3	—	0.2 V_{CC}	V	
	V_{ILM}	MD input pin	—	V_{SS} – 0.3	—	V_{SS} +0.3	V	
Output H voltage	V_{OH1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OH1} = –4.0 mA	V_{CC} – 0.5	—	—	V	
	V_{OH2}	P70 to P87	V_{CC} = 4.5 V, I_{OH2} = –30.0 mA	V_{CC} – 0.5	—	—	V	
Output L voltage	V_{OL1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OL1} = 4.0 mA	—	—	0.4	V	
	V_{OL2}	P70 to P87	V_{CC} = 4.5 V, I_{OL2} = 30.0 mA	—	—	0.5	V	

(Continued)

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input capacity	C_{IN}	Other than C, AV_{CC}, AV_{SS}, AVRH, AVRL, V_{CC}, V_{SS}, DV_{CC}, DV_{SS}, P70 to P87	—	—	5	15	pF	
		P70 to P87	—	—	15	30	pF	
Pull-up resistance	R_{UP}	$\overline{RST}$	—	25	50	100	kΩ	
Pull-down resistance	R_{DOWN}	MD2	—	25	50	100	kΩ	

* : The power supply current testing conditions are when using the external clock.

11.4 AC Characteristics

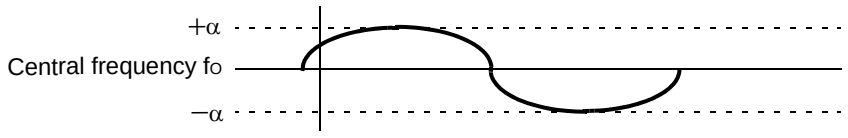
11.4.1 Clock Timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

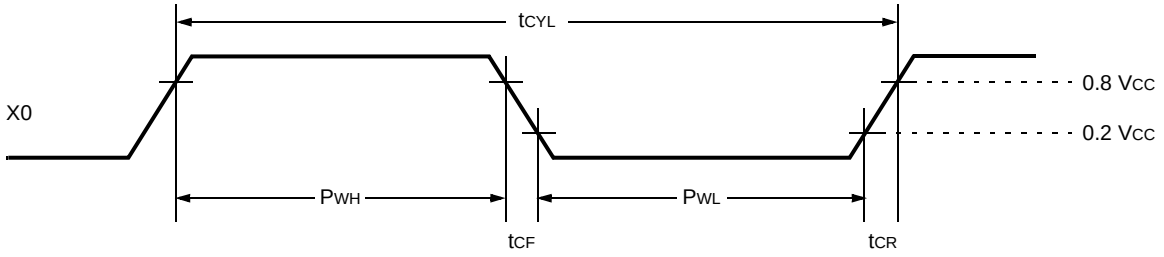
Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Oscillation frequency	f_C	X0, X1	3	—	5	MHz	When using oscillation circuit
Oscillation cycle time	t_{CYL}	X0, X1	200	—	333	ns	When using oscillation circuit
External clock frequency	f_C	X0, X1	3	—	16	MHz	When using external clock
External clock cycle time	t_{CYL}	X0, X1	62.5	—	333	ns	When using external clock
Frequency deviation with PLL *	Δf	—	—	—	5	%	
Input clock pulse width	P_{WH}, P_{WL}	X0	10	—	—	ns	Duty ratio is about 30 to 70%.
Input clock rise and fall time	t_{CR}, t_{CF}	X0	—	—	5	ns	When using external clock
Machine clock frequency	f_{CP}	—	1.5	—	16	MHz	
Machine clock cycle time	t_{CP}	—	62.5	—	666	ns	
Flash Read cycle time	t_{CYL}	—	—	2*t_{CP}	—	ns	When Flash is accessed via CPU

*: Frequency deviation indicates the maximum frequency difference from the target frequency when using a multiplied clock.

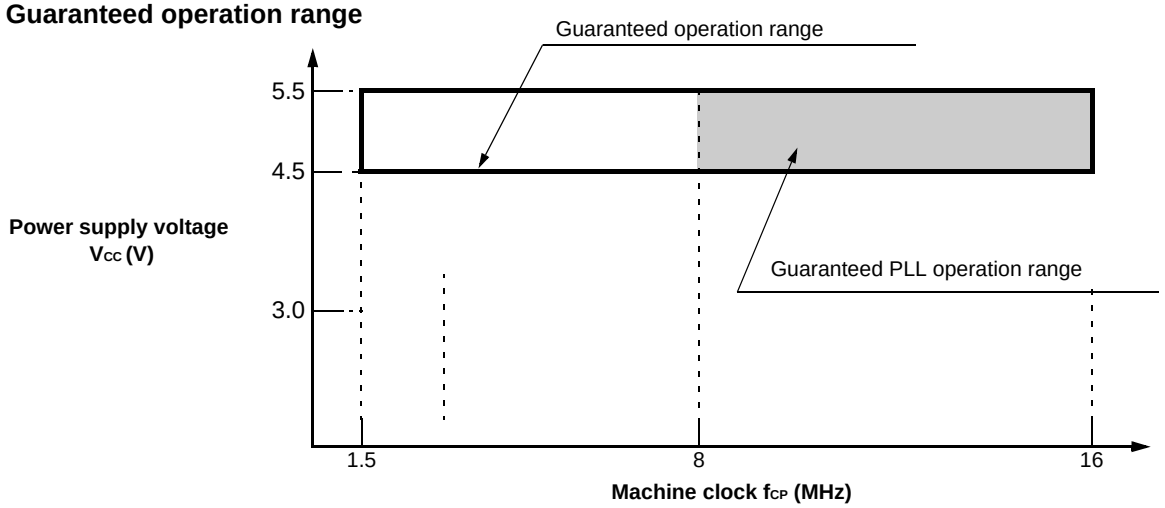
$$\Delta f = \frac{|\alpha|}{fo} \times 100\%$$



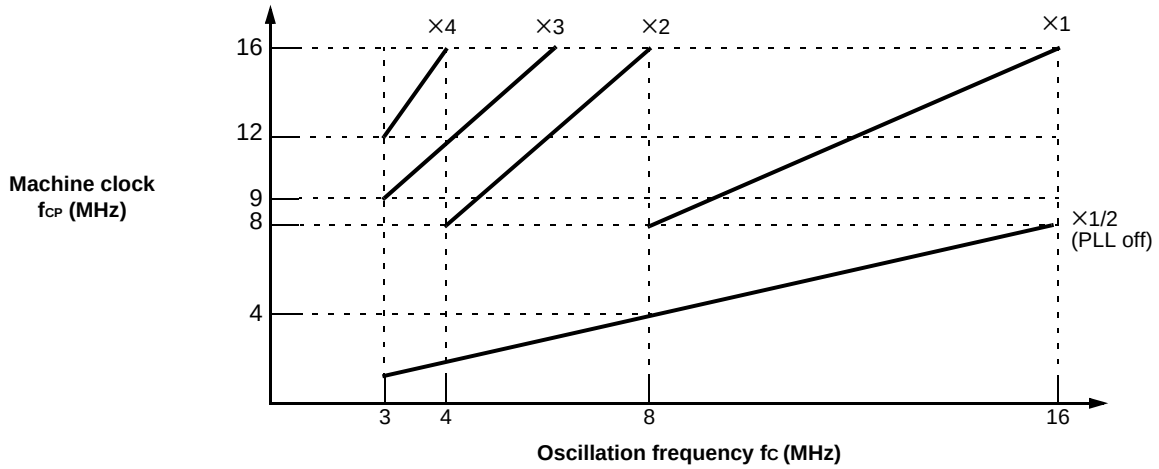
- **Clock Timing**



- **Guaranteed operation range**



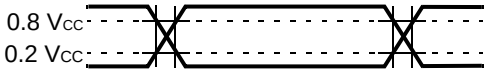
- **Oscillation frequency and machine clock frequency**



AC characteristics are set to the measured reference voltage values below.

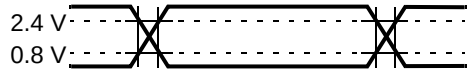
- **Input signal waveform**

Hysteresis Input Pin

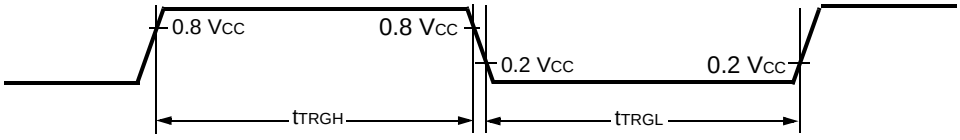


- **Output signal waveform**

Output Pin



- **Trigger Input Timing**



11.4.6 Slew Rate High Current Outputs (MB90598G, MB90F598G only)

(V_{CC} = 5.0 V±10 %, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Output Rise/Fall time	t_{R2} t_{F2}	Port P70 to P77, Port P80 to P87	—	15	40	150	ns	

- Slew Rate Output Timing

$V_H = V_{OL2} + 0.1 \times (V_{OH2} - V_{OL2})$
$V_L = V_{OL2} + 0.9 \times (V_{OH2} - V_{OL2})$

11.5 A/D Converter

(V_{CC} = AV_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V,3.0 V ≤ AVRH − AVRL, T_A = −40 °C to +85 °C)

Parameter	Sym-bol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—		10	bit	
Conversion error	—	—	—	—	±5.0	LSB	
Nonlinearity error	—	—	—	—	±2.5	LSB	
Differential linearity error	—	—	—	—	±1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	AVRL − 3.5 LSB	AVRL + 0.5 LSB	AVRL + 4.5 LSB	V	
Full scale transition voltage	V_{FST}	AN0 to AN7	AVRH − 6.5 LSB	AVRH − 1.5 LSB	AVRH + 1.5 LSB	V	
Conversion time	—	—	—	352t_{CP}	—	ns	
Sampling time	—	—	—	64t_{CP}	—	ns	
Analog port input current	I_{AIN}	AN0 to AN7	−10	—	10	µA	
Analog input voltage range	V_{AIN}	AN0 to AN7	AVRL	—	AVRH	V	

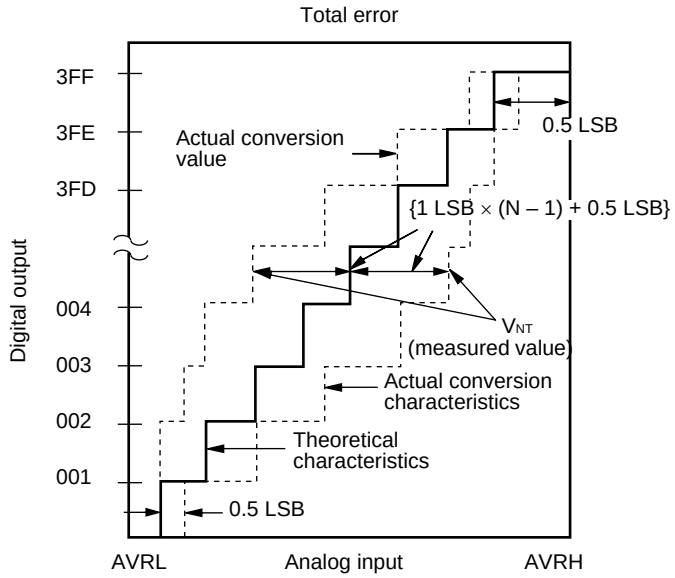
11.6 A/D Converter Glossary

Resolution: Analog changes that are identifiable with the A/D converter

Linearity error: The deviation of the straight line connecting the zero transition point (“00 0000 0000” ↔ “00 0000 0001”) with the full-scale transition point (“11 1111 1110” ↔ “11 1111 1111”) from actual conversion characteristics

Differential linearity error: The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value

Total error: The total error is defined as a difference between the actual value and the theoretical value, which includes zero-transition error/full-scale transition error and linearity error.



1 LSB = (Theoretical value) $\frac{AVRH - AVRL}{1024}$ [V]

Total error for digital output N = $\frac{V_{NT} - \{1\ LSB \times (N - 1) + 0.5\ LSB\}}{1\ LSB}$ [LSB]

V_{OT} (Theoretical value) = AVRL + 0.5 LSB[V]

V_{NT}: Voltage at a transition of digital output from (N – 1) to N

V_{FST} (Theoretical value) = AVRH – 1.5 LSB[V]

(Continued)

11.8 Flash memory

■ Erase and programming performance

Parameter	Condition	Value			Unit	Remarks	
		Min	Typ	Max			
Sector erase time	$T_A = +25\ ^{\circ}C$, $V_{CC} = 5.0$ V	—	1	15	s	MB90F598G	Excludes 00H programming prior erasure
Chip erase time		—	5	—	s	MB90F598G	Excludes 00H programming prior
Word (16-bit) programming time		—	16	3600	µs	MB90F598G	Excludes system-level overhead
Erase/Program cycle	—	10000	—	—	cycle		

15. Major Changes

Spansion Publication Number: DS07-13705-7E

Section	Change Results
—	Deleted the old products, MB90598, MB90F598, and MB90V595.
—	Changed the series name; MB90595/595G series ? MB90595G series
—	Changed the following erroneous name. I/O timer → 16-bit Free-run Timer
PRODUCT LINEUP	One of Standby mode name is changed. Clock mode → Watch mode
I/O CIRCUIT TYPE	Changed Pull-down resistor value of circuit type H.
ELECTRICAL CHARACTERISTICS AC Characteristics	Add the “External clock input” and “Flash Read cycle time” in (1) Clock Timing
	Figure in (2) Reset and Hardware Standby Input RST/HST input level of “In Stop Mode” is changed. 0.6 V_{CC} 0.2 V_{CC}
ELECTRICAL CHARACTERISTICS 5. A/D Converter	Changed the items of “Zero transition voltage” and “Full scale transition voltage”.

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: MB90598G/F598G/V595G F²MC-16LX MB90595G Series CMOS 16-bit Proprietary Microcontroller Document Number: 002-07700				
Revision	**ECN**	**Orig. of Change**	**Submission Date**	**Description of Change**
**	—	AKIH	09/26/2008	Migrated to Cypress and assigned document number 002-07700. No change to document contents or format.
*A	5537128	AKIH	11/30/2016	Updated to Cypress template

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